

Electronic Patent Application Fee Transmittal

Application Number:	10567358			
Filing Date:	06-Feb-2006			
Title of Invention:	Flip chip mounting substrate			
First Named Inventor/Applicant Name:	Yasukazu Nakata			
Filer:	Laura Moskowitz/betty smith			
Attorney Docket Number:	Q92997			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 1 month with \$0 paid	1251	1	120	120

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				910